

18A, 600V N-CHANNEL POWER MOSFET

■ DESCRIPTION

The UTC **18N60** uses UTC's advanced proprietary, planar stripe, DMOS technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.



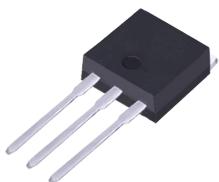
TO-220

■ FEATURES

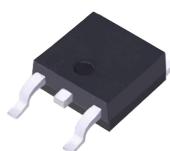
- * $R_{DS(ON)} \leq 0.5 \Omega$ @ $V_{GS}=10V$, $I_D=9.0A$
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness



TO-220F



TO-262



TO-263



TO-251



TO-252

■ **ABSOLUTE MAXIMUM RATINGS** ($T_c = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	600	V
Gate-Source Voltage	V_{GSS}	± 30	V
Continuous Drain Current	I_D	18	A
Pulsed Drain Current	I_{DM}	45	A
Avalanche Current	I_{AR}	18	A
Avalanche Energy Single Pulsed	E_{AS}	506 (Note 2)	mJ
Peak Diode Recovery dv/dt	dv/dt	3.35	V/ns
Power Dissipation TO-247	P_D	360	W
		395	W
Junction Temperature	T_J	+150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. L=6.18mH, $I_{AS}=12.8\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$

■ **THERMAL DATA**

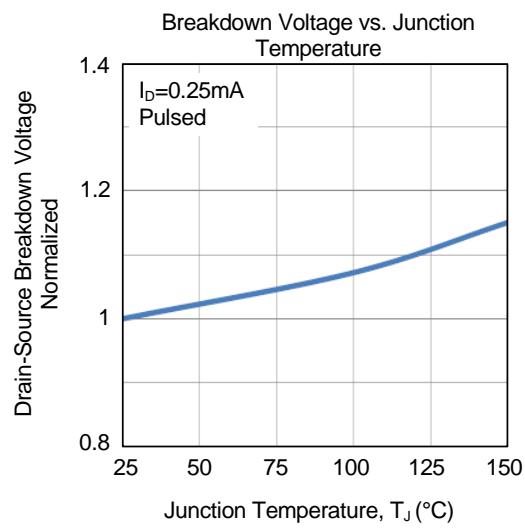
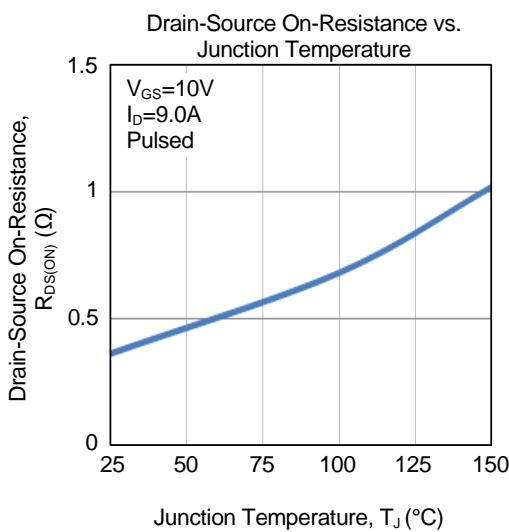
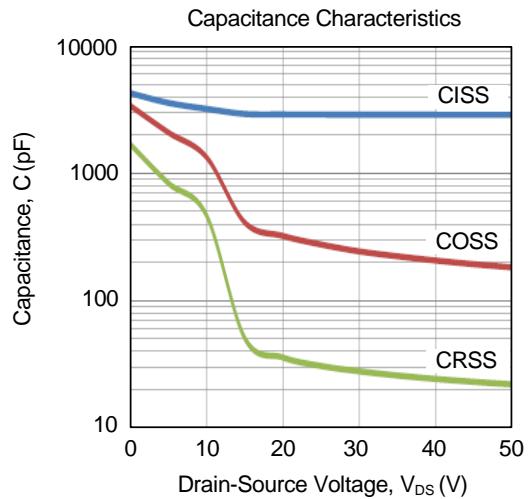
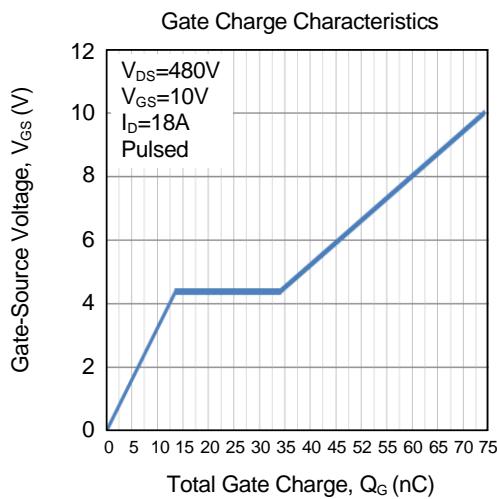
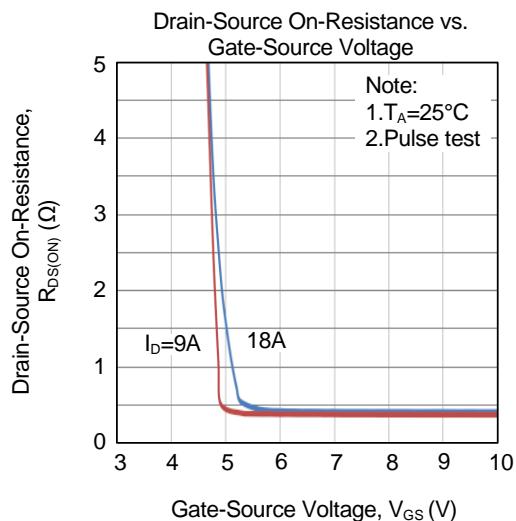
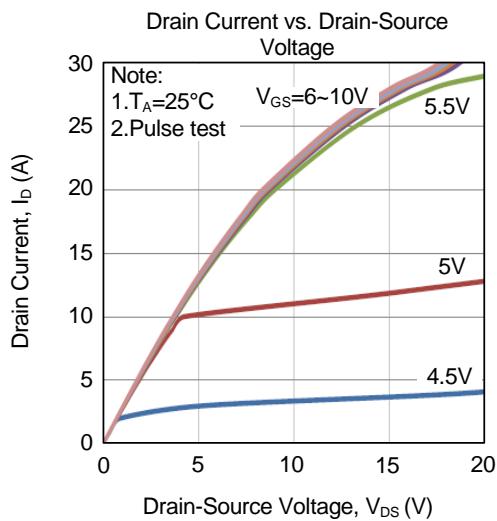
PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	40	$^\circ\text{C}/\text{W}$
		30	
Junction to Case	θ_{JC}	0.35	$^\circ\text{C}/\text{W}$
		0.32	

■ ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$, unless otherwise specified)

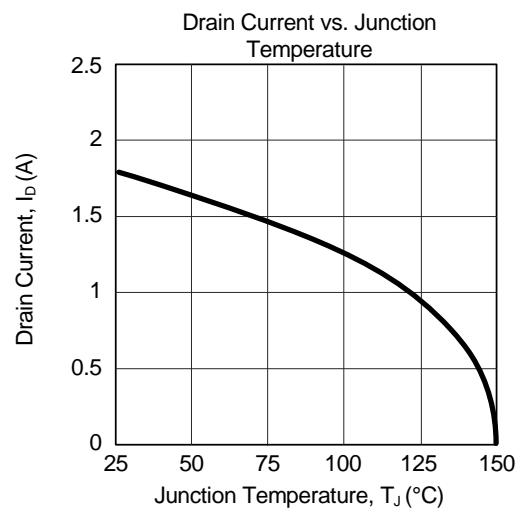
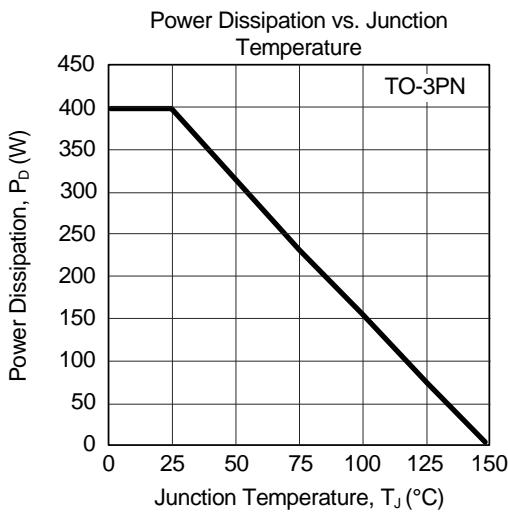
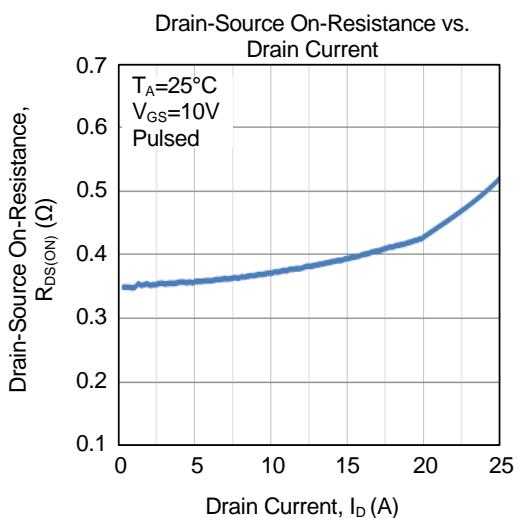
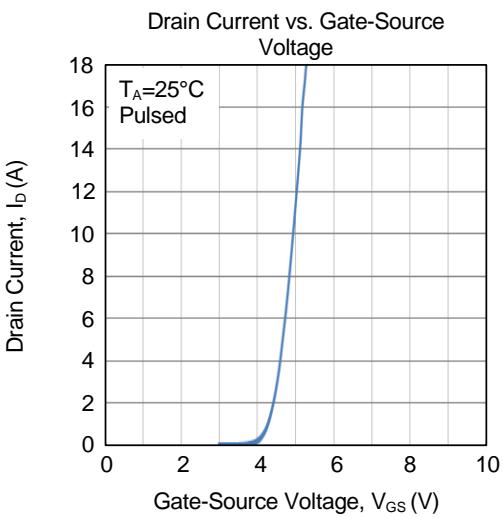
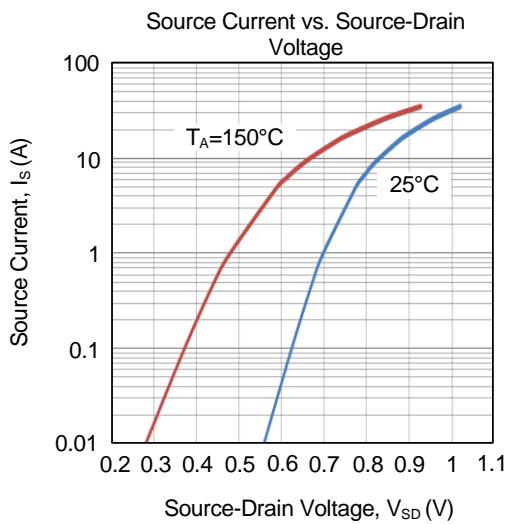
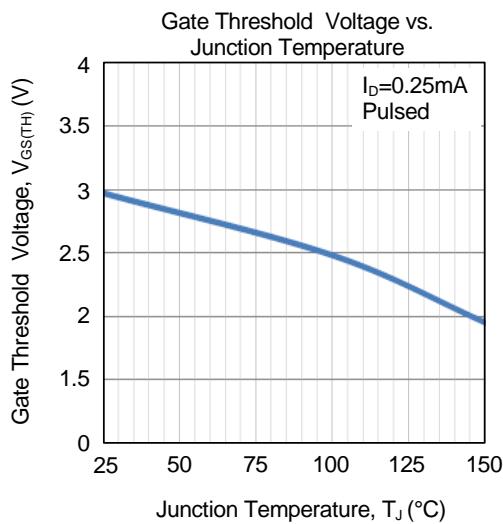
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	600			V
Drain-Source Leakage Current	I_{DSS}	$V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}$			25	μA
Gate-Body Leakage Current	I_{GSS}	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}=\pm 30\text{V}$			± 100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{\text{GS}(\text{TH})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0		4.0	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=9\text{A}$ (Note)		0.36	0.5	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$		2900		pF
Output Capacitance	C_{OSS}			275		pF
Reverse Transfer Capacitance	C_{RSS}			30		pF
SWITCHING PARAMETERS						
Total Gate Charge	Q_G	$V_{\text{DS}}=480\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=18\text{A}$ $I_{\text{G}}=1\text{mA}$ (Note 1, 2)		75		nC
Gate Source Charge	Q_{GS}			15		nC
Gate Drain Charge	Q_{GD}			20		nC
Turn-ON Delay Time	$t_{\text{D}(\text{ON})}$	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=18\text{A}$, $R_{\text{GS}}=25\Omega$		40		ns
Turn-ON Rise Time	t_R			26		ns
Turn-OFF Delay Time	$t_{\text{D}(\text{OFF})}$			232		ns
Turn-OFF Fall-Time	t_F			65		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Continuous Drain-Source Diode Forward Current	I_S	$V_{\text{GS}}=0\text{V}$			18	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}	Repetitive			54	A
Drain-Source Diode Forward Voltage	V_{SD}	$I_{\text{F}}=I_S, V_{\text{GS}}=0\text{V}$ (Note)			1.5	V
Reverse Recovery Time	t_{rr}	$V_{\text{GS}}=0\text{V}, \frac{dI_{\text{F}}}{dt}=100\text{A}/\mu\text{s}$, $I_S=18\text{A}, V_R=400\text{V}$		500		ns
Reverse Recovery Charge	Q_{rr}			18		μC

Note: Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.

■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)